

LOCTITE[®] AA 3108™

Known as LOCTITE[®] 3108™ December 2014

PRODUCT DESCRIPTION

LOCTITE[®] AA 3108™ provides the following product characteristics:

Technology	Acrylic			
Chemical Type	Acrylated urethane			
Appearance (uncured)	Translucent colorless liquid ^{LMS}			
Components	One component -			
	requires no mixing			
Viscosity	Medium			
Cure	Ultraviolet (UV) light			
Cure Benefit	Production - high speed curing			
Application	Bonding			
Flexibility	Enhances load bearing & shock absorbing characteristics of the bond area.			

LOCTITE[®] AA 3108[™] is designed primarly for potting and sealing glass to metal joints that must withstand thermal cycling and environmental exposure. The product has shown excellent capabilities in bonding dissimilar rigid substrates.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Specific Gravity @ 25 °C 1.08
Flash Point - See SDS
Viscosity, Brookfield - RVT, 25 °C, mPa·s (cP):
Spindle 4, speed 20 rpm, 3,600 to 6,600^{LMS}

TYPICAL CURING PERFORMANCE

LOCTITE[®] AA 3108[™] can be cured by exposure to UV light at 365 nm. Surface cure is enhanced by exposure to UV light in the 220 to 260 nm range. Cure rate and ultimate depth of cure depend on light intensity, spectral distribution of the light source, exposure time and light transmittance of the substrate through which the light must pass.

Fixture Time

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm².

UV Fixture Time, Glass, seconds:

Medium Pressure Hg Arc bulb, Zeta[®] 7200 light source: 50 mW/cm², measured @ 365 nm ≤15^{LMS}

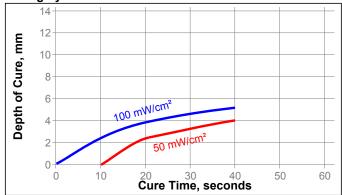
Electrodeless, D bulb:

100 mW/cm², measured @ 365 nm

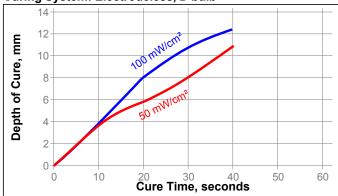
Depth of Cure vs. Irradiance (365 nm)

The graphs below show the increase in depth of cure with time at 50 mW/cm² and 100 mW/cm² as measured from the thickness of the cured test piece.

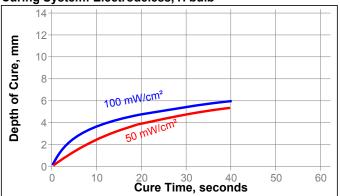
Curing System: Zeta® 7200



Curing System: Electrodeless, D bulb



Curing System: Electrodeless, H bulb





TYPICAL PROPERTIES OF CURED MATERIAL

Cured @ 100 $\,$ mW/cm² , for 30 seconds using an Electrodeless system, D bulb

Physical Properties:

Shore Hardness, ISO 868, Durometer A ≥72^{LMS}

Water Absorption, ISO 62, %:

2 hours in boiling water 4.9 Elongation, at break, ISO 527-3, % 330 Tensile Modulus, ISO 527-3 N/mm² 18.6

(psi) (2,670)

Tensile Strength, at break, ISO N/mm² 7.91 527-3 (psi) (1,135)

UV Depth of Cure, mm:

Cured @ 100 mW/cm² , measured @ \geq 1.6 LMS

365 nm.

for 15 seconds

Electrical Properties:

Surface Resistivity, IEC 60093, Ω -cm 7.84×10¹⁴ Volume Resistivity, IEC 60093, Ω -cm 1.06×10¹⁴

Dielectric Breakdown Strength,

IEC 60243-1, kV/mm

Dielectric Constant / Dissipation Factor, IEC 60250: 100 Hz 7.47 / 0.19 1 kHz 6.8 / 0.07 1 MHz 5.59 / 0.05

TYPICAL PERFORMANCE OF CURED MATERIAL Adhesive Properties

Cured @ 100 mW/cm² , measured @ 365 nm, for 30 seconds using an Electrodeless system, D bulb, (samples with 0.127 mm gap)

Block Shear Strength, ISO 13445:

Cured @ 100 mW/cm 2 , measured @ 365 nm, for 30 seconds using a medium pressure Hg Arc bulb, Zeta $^{\otimes}$ 7200 light source

Block Shear Strength, ISO 13445:

Polycarbonate to N/mm² ≥5.5^{LMS} Polycarbonate (psi) (≥797)

TYPICAL ENVIRONMENTAL RESISTANCE

Cured @ 100 mW/cm 2 , measured @ 365 nm, for 30 seconds using an Electrodeless system, D bulb

Block Shear Strength, ISO 13445:

Polycarbonate:

0.127 mm gap

Chemical/Solvent Resistance

Aged under conditions indicated and tested @ 22 °C.

		% of initial strength		
Environment	°C	100 h	500 h	1000 h
Water immersion	22	75	40	45
Heat/humidity 95% RH	38	80	100	100
Salt fog	35	65	55	60

GENERAL INFORMATION

This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials.

For safe handling information on this product, consult the Safety Data Sheet (SDS).

Directions for use:

- This product is light sensitive; exposure to daylight, UV light and artificial lighting should be kept to a minimum during storage and handling.
- The product should be dispensed from applicators with black feedlines.
- 3. For best performance bond surfaces should be clean and free from grease.
- Cure rate is dependent on lamp intensity, distance from light source, depth of cure needed or bondline gap and light transmittance of the substrate through which the radiation must pass.
- Cooling should be provided for temperature sensitive substrates such as thermoplastics.
- Plastic grades should be checked for risk of stress cracking when exposed to liquid adhesive.
- 7. Excess uncured adhesive can be wiped away with organic solvent (e.g. Acetone).
- Bonds should be allowed to cool before subjecting to any service loads.

Loctite Material Specification^{LMS}

LMS dated July 3, 2003. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 2 °C to 8 °C. Storage below 2 °C or greater than 8 °C can adversely affect product properties. Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$ $kV/mm \times 25.4 = V/mil$ mm / 25.4 = inches $\mu m / 25.4 = mil$ $N \times 0.225 = lb$ $N/mm \times 5.71 = lb/in$ $N/mm^2 \times 145 = psi$ $MPa \times 145 = psi$ $N \cdot m \times 8.851 = lb \cdot in$ $N \cdot m \times 0.738 = lb \cdot ft$ $N \cdot mm \times 0.742 = oz \cdot in$ $mPa \cdot s = cP$

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Belgium NV, Henkel Electronic Materials NV, Henkel Nederland BV, Henkel Technologies France SAS and Henkel France SA please additionally note the following:

In case Henkel would be nevertheless held liable, on whatever legal ground, Henkel's liability will in no event exceed the amount of the concerned delivery.

In case products are delivered by Henkel Colombiana, S.A.S. the following disclaimer is applicable:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

In case products are delivered by Henkel Corporation, Resin Technology Group, Inc., or Henkel Canada Corporation, the following disclaimer is applicable:

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

Trademark usage

Except as otherwise noted, all trademarks in this document are trademarks of Henkel Corporation in the U.S. and elsewhere. [®] denotes a trademark registered in the U.S. Patent and Trademark Office.

Reference 1.3